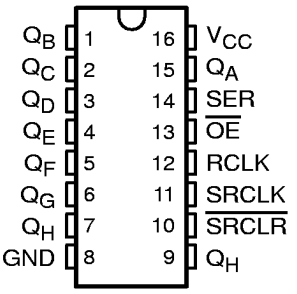
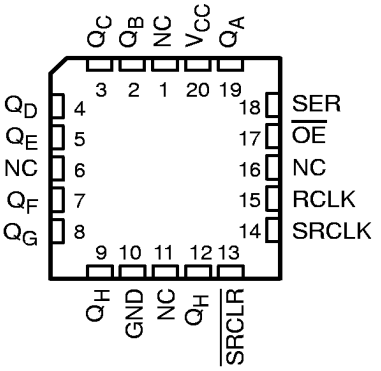
- *EPIC*™ (Enhanced-Performance Implanted CMOS) Process
- Typical V_{OLP} (Output Ground Bounce) < 0.8 V at V_{CC} = 3.3 V, T_A = 25°C
- Typical V_{OHV} (Output V_{OH} Undershoot) > 2 V at V_{CC} = 3.3 V, T_A = 25°C
- 8-Bit Serial-In, Parallel-Out Shift
- Shift Register Has Direct Clear
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Package Options Include Plastic Small-Outline (D, NS), Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages, Ceramic Flat (W) Packages, Chip Carriers (FK), and DIPs (J)

SN54LV595A . . . J OR W PACKAGE
SN74LV595A . . . D, DB, NS, OR PW PACKAGE
(TOP VIEW)



SN54LV595A . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

description

The 'LV595A devices are 8-bit shift registers designed for 2-V to 5.5-V V_{CC} operation.

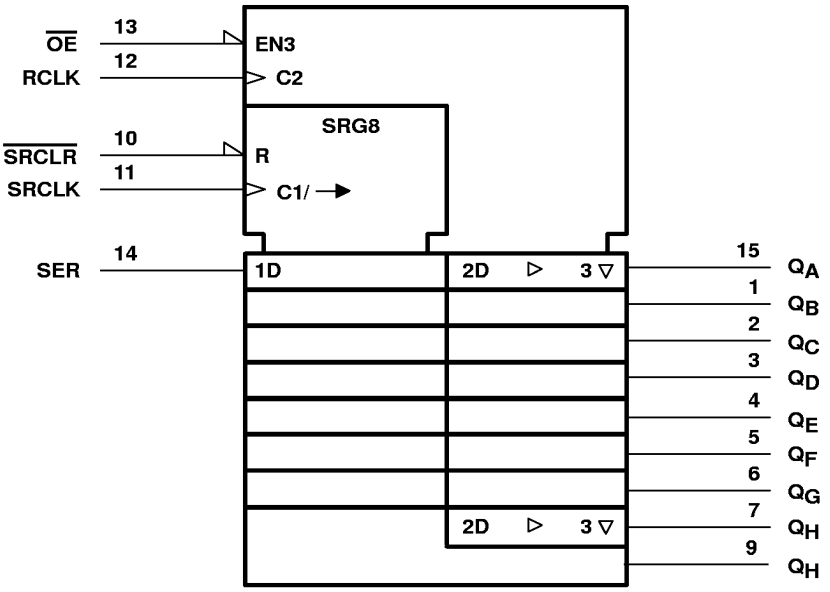
These devices contain an 8-bit serial-in, parallel-out shift register that feeds an 8-bit D-type storage register. The storage register has parallel 3-state outputs. Separate clocks are provided for both the shift and storage register. The shift register has a direct overriding clear ($\overline{SRCLR}$) input, serial (SER) input, and a serial output for cascading. When the output-enable ($\overline{OE}$) input is high, all outputs except Q_H are in the high-impedance state.

Both the shift register clock (SRCLK) and storage register clock (RCLK) are positive-edge triggered. If both clocks are connected together, the shift register is always one clock pulse ahead of the storage register.

To ensure the high-impedance state during power up or power down, $\overline{OE}$ should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

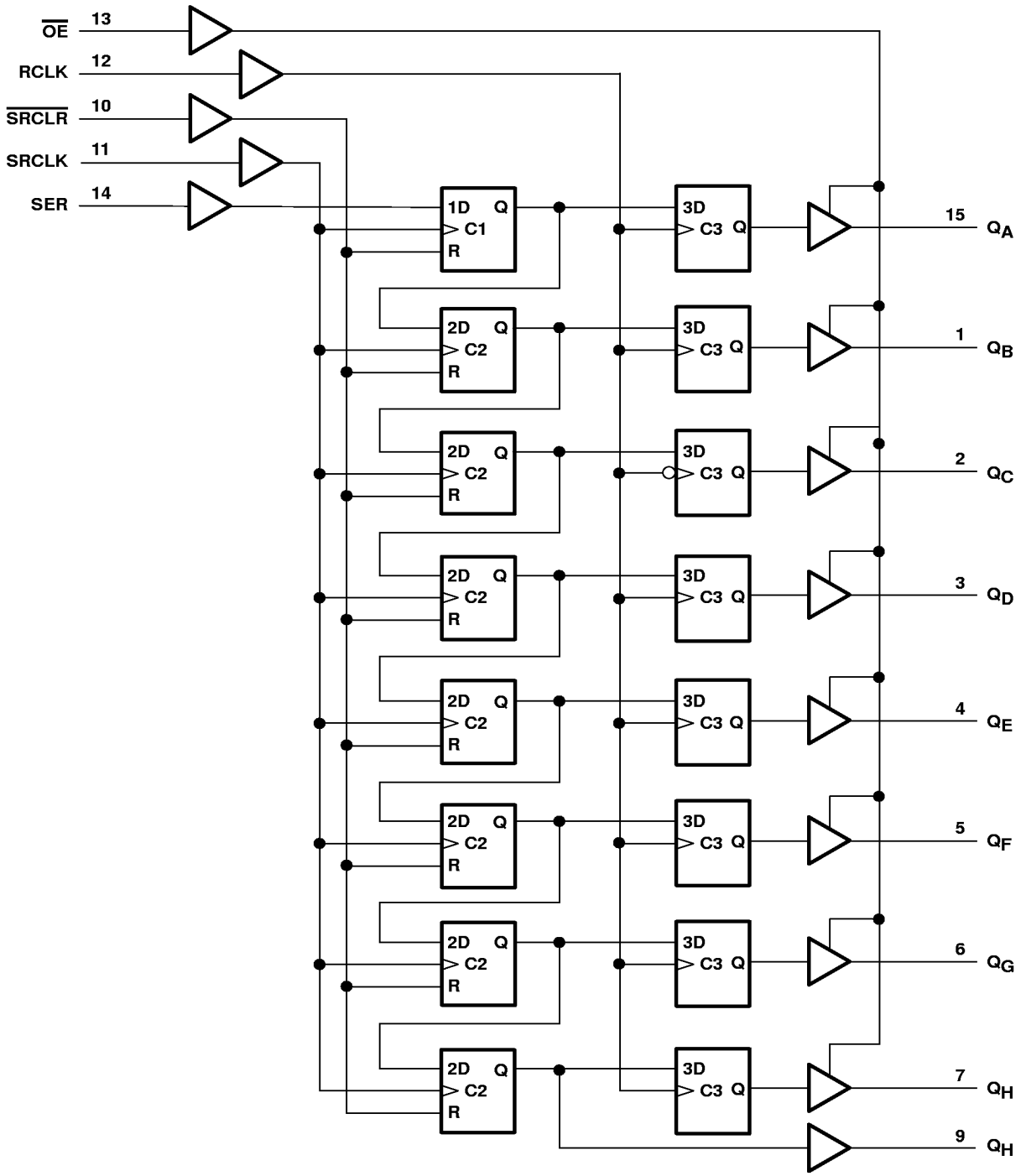
The SN54LV595A is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74LV595A is characterized for operation from –40°C to 85°C.

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for the D, DB, J, NS, PW, and W packages.

logic diagram (positive logic)



Pin numbers shown are for the D, DB, J, NS, PW, and W packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC} . . . . . –0.5 V to 7 V
Input voltage range, V_I (see Note 1) . . . . . –0.5 V to 7 V
Output voltage range applied in the high or low state, V_O (see Notes 1 and 2) . . . . . –0.5 V to V_{CC} + 0.5 V
Output voltage range applied in high-impedance or power-off state, V_O (see Note 1) . . . . . –0.5 V to 7 V
Input clamp current, I_{IK} (V_I < 0) . . . . . –20 mA
Output clamp current, I_{OK} (V_O < 0 or V_O > V_{CC}) . . . . . ±50 mA
Continuous output current, I_O (V_O = 0 to V_{CC}) . . . . . ±35 mA
Continuous current through V_{CC} or GND . . . . . ±70 mA
Package thermal impedance, θ_{JA} (see Note 3): D package . . . . . 113°C/W
DB package . . . . . 131°C/W
NS package . . . . . 111°C/W
PW package . . . . . 149°C/W
Storage temperature range, T_{stg} . . . . . –65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. This value is limited to 7 V maximum.
3. The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions (see Note 4)

			SN54LV595A		SN74LV595A		UNIT
			MIN	MAX	MIN	MAX	
V_{CC}	Supply voltage		2	5.5	2	5.5	V
V_{IH}	High-level input voltage	V_{CC} = 2 V	1.5		1.5		V
		V_{CC} = 2.3 V to 2.7 V	$V_{CC} \times 0.7$		$V_{CC} \times 0.7$		
		V_{CC} = 3 V to 3.6 V	$V_{CC} \times 0.7$		$V_{CC} \times 0.7$		
		V_{CC} = 4.5 V to 5.5 V	$V_{CC} \times 0.7$		$V_{CC} \times 0.7$		
V_{IL}	Low-level input voltage	V_{CC} = 2 V		0.5		0.5	V
		V_{CC} = 2.3 V to 2.7 V		$V_{CC} \times 0.3$		$V_{CC} \times 0.3$	
		V_{CC} = 3 V to 3.6 V		$V_{CC} \times 0.3$		$V_{CC} \times 0.3$	
		V_{CC} = 4.5 V to 5.5 V		$V_{CC} \times 0.3$		$V_{CC} \times 0.3$	
V_I	Input voltage		0	5.5	0	5.5	V
V_O	Output voltage	High or low state	0	V_{CC}	0	V_{CC}	V
		3-state	0	5.5	0	5.5	
I_{OH}	High-level output current	V_{CC} = 2 V		–50		–50	μA
		V_{CC} = 2.3 V to 2.7 V		–2		–2	mA
		V_{CC} = 3 V to 3.6 V		–8		–8	
		V_{CC} = 4.5 V to 5.5 V		–16		–16	
I_{OL}	Low-level output current	V_{CC} = 2 V		50		50	μA
		V_{CC} = 2.3 V to 2.7 V		2		2	mA
		V_{CC} = 3 V to 3.6 V		8		8	
		V_{CC} = 4.5 V to 5.5 V		16		16	
$\Delta t/\Delta v$	Input transition rise or fall rate	V_{CC} = 2.3 V to 2.7 V	0	200	0	200	ns/V
		V_{CC} = 3 V to 3.6 V	0	100	0	100	
		V_{CC} = 4.5 V to 5.5 V	0	20	0	20	
T_A	Operating free-air temperature		–55	125	–40	85	°C

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V_{CC}	SN54LV595A			SN74LV595A			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	
V_{OH}		I_{OH} = –50 μA	2 V to 5.5 V	V_{CC}–0.1			V_{CC}–0.1			V
		I_{OH} = –2 mA	2.3 V	2			2			
	Q_H	I_{OH} = –6 mA	3 V	2.48			2.48			
	Q_A–Q_H	I_{OH} = –8 mA		2.48			2.48			
	Q_H	I_{OH} = –12 mA	4.5 V	3.8			3.8			
	Q_A–Q_H	I_{OH} = –16 mA		3.8			3.8			
V_{OL}		I_{OL} = 50 μA	2 V to 5.5 V			0.1			0.1	V
		I_{OL} = 2 mA	2.3 V			0.4			0.4	
	Q_H	I_{OL} = 6 mA	3 V			0.44			0.44	
	Q_A–Q_H	I_{OL} = 8 mA				0.44			0.44	
	Q_H	I_{OL} = 12 mA	4.5 V			0.55			0.55	
	Q_A–Q_H	I_{OL} = 16 mA				0.55			0.55	
I_I		V_I = V_{CC} or GND	5.5 V			±1			±1	μA
I_{OZ}		V_O = V_{CC} or GND	5.5 V			±5			±5	μA
I_{CC}		V_I = V_{CC} or GND I_O = 0	5.5 V			20			20	μA
I_{off}		V_I or V_O = 0 to 5.5 V	0 V			5			5	μA
C_i		V_I = V_{CC} or GND	3.3 V		3.5			3.5		pF
			5 V		3			3		

timing requirements over recommended operating free-air temperature range, V_{CC} = 2.5 V ± 0.2 V (unless otherwise noted) (see Figure 1)

			T_A = 25°C	SN54LV595A	SN74LV595A	UNIT
			MIN MAX	MIN MAX	MIN MAX	
t_w	Pulse duration	SRCLK high or low	7	7.5	7.5	ns
		RCLK high or low	7	7.5	7.5	
		$\overline{\text{SRCLR}}$ low	6	6.5	6.5	
t_{su}	Setup time	SER before SRCLK↑	2.5	3	3	ns
		SRCLK↑ before RCLK↑†	8	9	9	
		$\overline{\text{SRCLR}}$ low before RCLK↑	8.5	9.5	9.5	
		$\overline{\text{SRCLR}}$ high (inactive) before SRCLK↑	4	4	4	
t_h	Hold time	SER after SRCLK↑	1.5	1.5	1.5	ns

† This setup time allows the storage register to receive stable data from the shift register. The clocks can be tied together, in which case the shift register is one clock pulse ahead of the storage register.

timing requirements over recommended operating free-air temperature range, V_{CC} = 3.3 V ± 0.3 V (unless otherwise noted) (see Figure 1)

			T_A = 25°C		SN54LV595A		SN74LV595A		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
t_w	Pulse duration	SRCLK high or low		5.5		5.5		5.5	ns
		RCLK high or low		5.5		5.5		5.5	
		$\overline{\text{SRCLR}}$ low		5		5		5	
t_{su}	Setup time	SER before SRCLK↑		3.5		3.5		3.5	ns
		SRCLK↑ before RCLK↑†		8		8.5		8.5	
		$\overline{\text{SRCLR}}$ low before RCLK↑		8		9		9	
		$\overline{\text{SRCLR}}$ high (inactive) before SRCLK↑		3		3		3	
t_h	Hold time	SER after SRCLK↑		1.5		1.5		1.5	ns

† This setup time allows the storage register to receive stable data from the shift register. The clocks can be tied together, in which case the shift register is one clock pulse ahead of the storage register.

timing requirements over recommended operating free-air temperature range, V_{CC} = 5 V ± 0.5 V (unless otherwise noted) (see Figure 1)

			T_A = 25°C		SN54LV595A		SN74LV595A		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
t_w	Pulse duration	SRCLK high or low		5		5		5	ns
		RCLK high or low		5		5		5	
		$\overline{\text{SRCLR}}$ low		5.2		5.2		5.2	
t_{su}	Setup time	SER before SRCLK↑		3		3		3	ns
		SRCLK↑ before RCLK↑†		5		5		5	
		$\overline{\text{SRCLR}}$ low before RCLK↑		5		5		5	
		$\overline{\text{SRCLR}}$ high (inactive) before SRCLK↑		2.5		2.5		2.5	
t_h	Hold time	SER after SRCLK↑		2		2		2	ns

† This setup time allows the storage register to receive stable data from the shift register. The clocks can be tied together, in which case the shift register is one clock pulse ahead of the storage register.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 2.5 V ± 0.2 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T_A = 25°C			SN54LV595A		SN74LV595A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f_{max}			C_L = 15 pF*	65	80		45		45		MHz
			C_L = 50 pF	60	70		40		40		
t_{PLH}*	RCLK	Q_A–Q_H	C_L = 15 pF		8.4	14.2	1	15.8	1	15.8	ns
t_{PHL}*					8.4	14.2	1	15.8	1	15.8	
t_{PLH}*	SRCLK	Q_H			9.4	19.6	1	22.2	1	22.2	
t_{PHL}*					9.4	19.6	1	22.2	1	22.2	
t_{PHL}*	$\overline{SRCLR}$	Q_H			8.7	14.6	1	16.3	1	16.3	
t_{PZH}*	$\overline{OE}$	Q_A–Q_H			8.2	13.9	1	15	1	15	
t_{PZL}*					10.9	18.1	1	20.3	1	20.3	
t_{PHZ}*	$\overline{OE}$	Q_A–Q_H			8.3	13.7	1	15.6	1	15.6	
t_{PLZ}*					9.2	15.2	1	16.7	1	16.7	
t_{PLH}	RCLK	Q_A–Q_H	C_L = 50 pF		11.2	17.2	1	19.3	1	19.3	ns
t_{PHL}					11.2	17.2	1	19.3	1	19.3	
t_{PLH}	SRCLK	Q_H			13.1	22.5	1	25.5	1	25.5	
t_{PHL}					13.1	22.5	1	25.5	1	25.5	
t_{PHL}	$\overline{SRCLR}$	Q_H			12.4	18.8	1	21.1	1	21.1	
t_{PZH}	$\overline{OE}$	Q_A–Q_H			10.8	17	1	18.3	1	18.3	
t_{PZL}					13.4	21	1	23	1	23	
t_{PHZ}	$\overline{OE}$	Q_A–Q_H			12.2	18.3	1	19.5	1	19.5	
t_{PLZ}					14	20.9	1	22.6	1	22.6	

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V ± 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T_A = 25°C			SN54LV595A		SN74LV595A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f_{max}			C_L = 15 pF*	80	120		70		70		MHz
			C_L = 50 pF	55	105		50		50		
t_{PLH}*	RCLK	Q_A–Q_H	C_L = 15 pF		6	11.9	1	13.5	1	13.5	ns
t_{PHL}*					6	11.9	1	13.5	1	13.5	
t_{PLH}*	SRCLK	Q_H			6.6	13	1	15	1	15	
t_{PHL}*					6.6	13	1	15	1	15	
t_{PHL}*	$\overline{SRCLR}$	Q_H			6.2	12.8	1	13.7	1	13.7	
t_{PZH}*	$\overline{OE}$	Q_A–Q_H			6	11.5	1	13.5	1	13.5	
t_{PZL}*					7.8	11.5	1	13.5	1	13.5	
t_{PHZ}*	$\overline{OE}$	Q_A–Q_H			6.1	14.7	1	15.2	1	15.2	
t_{PLZ}*					6.3	14.7	1	15.2	1	15.2	
t_{PLH}	RCLK	Q_A–Q_H	C_L = 50 pF		7.9	15.4	1	17	1	17	ns
t_{PHL}					7.9	15.4	1	17	1	17	
t_{PLH}	SRCLK	Q_H			9.2	16.5	1	18.5	1	18.5	
t_{PHL}					9.2	16.5	1	18.5	1	18.5	
t_{PHL}	$\overline{SRCLR}$	Q_H			9	16.3	1	17.2	1	17.2	
t_{PZH}	$\overline{OE}$	Q_A–Q_H			7.8	15	1	17	1	17	
t_{PZL}					9.6	15	1	17	1	17	
t_{PHZ}	$\overline{OE}$	Q_A–Q_H			8.1	15.7	1	16.2	1	16.2	
t_{PLZ}					9.3	15.7	1	16.2	1	16.2	

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V ± 0.5 V (unless otherwise noted) (see Figure 1)

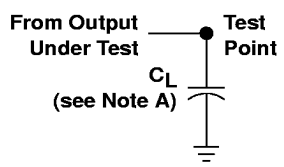
PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T_A = 25°C			SN54LV595A		SN74LV595A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f_{max}			C_L = 15 pF*	135	170		115		115		MHz
			C_L = 50 pF	120	140		95		95		
t_{PLH}*	RCLK	Q_A–Q_H	C_L = 15 pF		4.3	7.4	1	8.5	1	8.5	ns
t_{PHL}*					4.3	7.4	1	8.5	1	8.5	
t_{PLH}*	SRCLK	Q_H			4.5	8.2	1	9.4	1	9.4	
t_{PHL}*					4.5	8.2	1	9.4	1	9.4	
t_{PHL}*	$\overline{SRCLR}$	Q_H			4.5	8	1	9.1	1	9.1	
t_{PZH}*	$\overline{OE}$	Q_A–Q_H			4.3	8.6	1	10	1	10	
t_{PZL}*					5.4	8.6	1	10	1	10	
t_{PHZ}*	$\overline{OE}$	Q_A–Q_H			2.4	6	1	7.1	1	7.1	
t_{PLZ}*					2.7	5.1	1	7.2	1	7.2	
t_{PLH}	RCLK	Q_A–Q_H	C_L = 50 pF		5.6	9.4	1	10.5	1	10.5	ns
t_{PHL}					5.6	9.4	1	10.5	1	10.5	
t_{PLH}	SRCLK	Q_H			6.4	10.2	1	11.4	1	11.4	
t_{PHL}					6.4	10.2	1	11.4	1	11.4	
t_{PHL}	$\overline{SRCLR}$	Q_H			6.4	10	1	11.1	1	11.1	
t_{PZH}	$\overline{OE}$	Q_A–Q_H			5.7	10.6	1	12	1	12	
t_{PZL}					6.8	10.6	1	12	1	12	
t_{PHZ}	$\overline{OE}$	Q_A–Q_H			3.5	10.3	1	11	1	11	
t_{PLZ}					3.4	10.3	1	11	1	11	

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

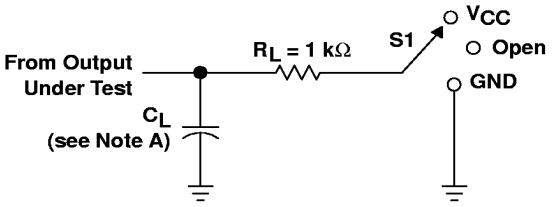
operating characteristics, T_A = 25°C

PARAMETER		TEST CONDITIONS	V_{CC}	TYP	UNIT
C_{pd}	Power dissipation capacitance	C_L = 50 pF, f = 10 MHz	3.3 V	32.7	pF
			5 V	33.1	

PARAMETER MEASUREMENT INFORMATION

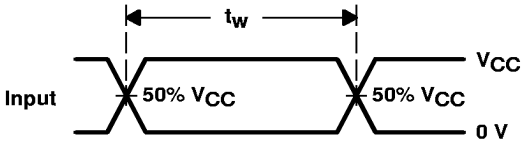


LOAD CIRCUIT FOR
TOTEM-POLE OUTPUTS

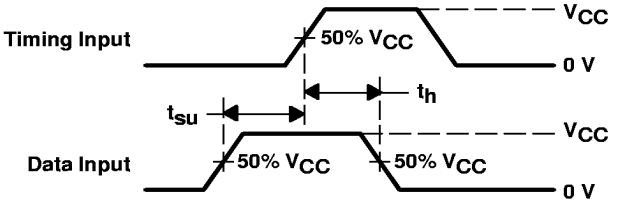


LOAD CIRCUIT FOR
3-STATE AND OPEN-DRAIN OUTPUTS

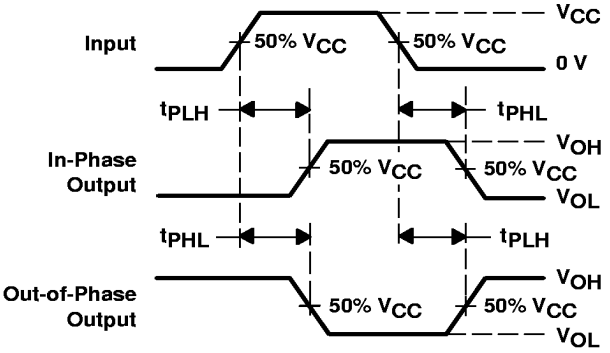
TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	V_{CC}
t_{PHZ}/t_{PZH}	GND
Open Drain	V_{CC}



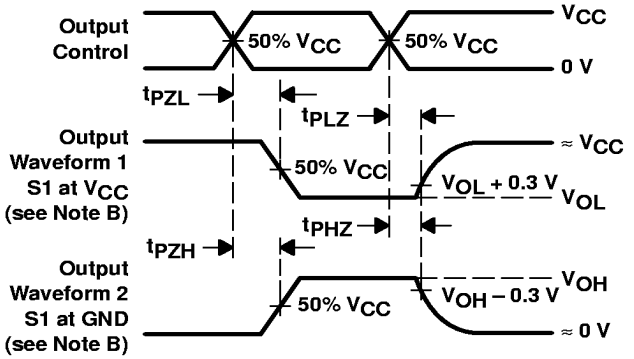
VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

NOTES: A. C_L includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, Z_O = 50 Ω, t_r ≤ 3 ns, t_f ≤ 3 ns.
D. The outputs are measured one at a time with one input transition per measurement.
E. t_{PLZ} and t_{PHZ} are the same as t_{dis}.
F. t_{PZL} and t_{PZH} are the same as t_{en}.
G. t_{PHL} and t_{PLH} are the same as t_{pd}.

Figure 1. Load Circuit and Voltage Waveforms